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TRANSMITTAL LETTER TO THE UNITED STATES
DESIGNATED/ELECTED OFFICE (DO/EO/US)
CONCERNING A FILING UNDER 35 U.S.C. 371

ATTORNEY'S DOCKET NUMBER

HEIN 19.272

U.S. APPLICATION NO. (If known, see 37 CFR 1.5)

10/018413

INTERNATIONAL APPLICATION NO.
PCT/FI00/00607INTERNATIONAL FILING DATE
03 JULY 2000 (03.07.00)PRIORITY DATE CLAIMED
01 JULY 1999 (01.07.99)

TITLE OF INVENTION

METHOD FOR THE MANUFACTURE OF A SENSOR ELEMENT, AND A SENSOR ELEMENT

APPLICANT(S) FOR DO/EO/US

Heikki RAISANEN

Applicant herewith submits to the United States Designated/Elected Office (DO/EO/US) the following items and other information:

1. ☒ This is a **FIRST** submission of items concerning a filing under 35 U.S.C. 371.
2. ☐ This is a **SECOND** or **SUBSEQUENT** submission of items concerning a filing under 35 U.S.C. 371.
3. ☒ This is an express request to begin national examination procedures (35 U.S.C. 371(f)). The submission must include items (5), (6), (9) and (21) indicated below.
4. ☒ The US has been elected by the expiration of 19 months from the priority date (Article 31).
5. ☒ A copy of the International Application as filed (35 U.S.C. 371(c)(2))
 - a. ☐ is attached hereto (required only if not communicated by the International Bureau).
 - b. ☒ has been communicated by the International Bureau.
 - c. ☐ is not required, as the application was filed in the United States Receiving Office (RO/US).
6. ☒ An English language translation of the International Application as filed (35 U.S.C. 371(c)(2))
 - a. ☒ is attached hereto.
 - b. ☐ has been previously submitted under 35 U.S.C. 154(d)(4).
7. ☒ Amendments to the claims of the International Application under PCT Article 19 (35 U.S.C. 371(c)(3))
 - a. ☐ are attached hereto (required only if not communicated by the International Bureau).
 - b. ☐ have been communicated by the International Bureau.
 - c. ☐ have not been made; however, the time limit for making such amendments has NOT expired.
 - d. ☒ have not been made and will not be made.
8. ☐ An English language translation of the amendments to the claims under PCT Article 19 (35 U.S.C. 371 (c)(3)).
9. ☐ An oath or declaration of the inventor(s) (35 U.S.C. 371(c)(4)).
10. ☐ An English language translation of the annexes of the International Preliminary Examination Report under PCT Article 36 (35 U.S.C. 371(c)(5)).

Items 11 to 20 below concern document(s) or information included:

11. ☐ An Information Disclosure Statement under 37 CFR 1.97 and 1.98.
12. ☐ An assignment document for recording. A separate cover sheet in compliance with 37 CFR 3.28 and 3.31 is included.
13. ☒ A FIRST preliminary amendment.
14. ☐ A SECOND or SUBSEQUENT preliminary amendment.
15. ☐ A substitute specification.
16. ☐ A change of power of attorney and/or address letter.
17. ☐ A computer-readable form of the sequence listing in accordance with PCT Rule 13ter.2 and 35 U.S.C. 1.821 - 1.825.
18. ☐ A second copy of the published international application under 35 U.S.C. 154(d)(4).
19. ☐ A second copy of the English language translation of the international application under 35 U.S.C. 154(d)(4).
20. ☐ Other items or information:

Filed by Express Mail
(Receipt No. EL868036022US)
on December 14, 2001

pursuant to 37 C.F.R. 1.10.

by [Signature]

U.S. APPLICATION NO. (if known, see 37 CFR 1.5) 10/018413		INTERNATIONAL APPLICATION NO. PCT/FI00/00607		ATTORNEY'S DOCKET NUMBER HEIN 19.272	
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21. <input checked="" type="checkbox"/> The following fees are submitted: BASIC NATIONAL FEE (37 CFR 1.492 (a) (1) - (5)): Neither international preliminary examination fee (37 CFR 1.482) nor international search fee (37 CFR 1.445(a)(2)) paid to USPTO and International Search Report not prepared by the EPO or JPO. \$1040.00 International preliminary examination fee (37 CFR 1.482) not paid to USPTO but International Search Report prepared by the EPO or JPO \$890.00 International preliminary examination fee (37 CFR 1.482) not paid to USPTO but international search fee (37 CFR 1.445(a)(2)) paid to USPTO \$740.00 International preliminary examination fee (37 CFR 1.482) paid to USPTO but all claims did not satisfy provisions of PCT Article 33(1)-(4) \$710.00 International preliminary examination fee (37 CFR 1.482) paid to USPTO and all claims satisfied provisions of PCT Article 33(1)-(4) \$100.00 ENTER APPROPRIATE BASIC FEE AMOUNT =				CALCULATIONS PTO USE ONLY <table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%; text-align: right;">\$1,040.00</td> <td style="width: 50%;"></td> </tr> <tr> <td style="text-align: right;">\$ 130.00</td> <td></td> </tr> </table>		\$1,040.00		\$ 130.00	
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Surcharge of \$130.00 for furnishing the oath or declaration later than <input type="checkbox"/> 20 <input checked="" type="checkbox"/> 30 months from the earliest claimed priority date (37 CFR 1.492(e)).				\$ 130.00	
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CLAIMS	NUMBER FILED	NUMBER EXTRA	RATE	\$	
Total claims	30 - 20 =	10	x \$18.00	\$ 180.00	
Independent claims	3 - 3 =	0	x \$84.00	\$	
MULTIPLE DEPENDENT CLAIM(S) (if applicable)			+ \$280.00	\$	
TOTAL OF ABOVE CALCULATIONS =				\$ 1,350.00	
<input type="checkbox"/> Applicant claims small entity status. See 37 CFR 1.27. The fees indicated above are reduced by 1/2.				\$	
SUBTOTAL =				\$	
Processing fee of \$130.00 for furnishing the English translation later than <input type="checkbox"/> 20 <input type="checkbox"/> 30 months from the earliest claimed priority date (37 CFR 1.492(f)).				\$	
TOTAL NATIONAL FEE =				\$ 1,350.00	
Fee for recording the enclosed assignment (37 CFR 1.21(h)). The assignment must be accompanied by an appropriate cover sheet (37 CFR 3.28, 3.31). \$40.00 per property +				\$	
TOTAL FEES ENCLOSED =				\$ 1,350.00	
				Amount to be refunded:	\$
				charged:	\$

a. ☐ A check in the amount of \$ _____ to cover the above fees is enclosed.

b. ☒ Please charge my Deposit Account No. 50-1290 in the amount of \$ 1,350.00 to cover the above fees. A duplicate copy of this sheet is enclosed.

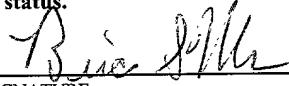
c. ☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1290. A duplicate copy of this sheet is enclosed.

d. ☐ Fees are to be charged to a credit card. **WARNING:** Information on this form may become public. **Credit card information should not be included on this form.** Provide credit card information and authorization on PTO-2038.

NOTE: Where an appropriate time limit under 37 CFR 1.494 or 1.495 has not been met, a petition to revive (37 CFR 1.137 (a) or (b)) must be filed and granted to restore the application to pending status.

SEND ALL CORRESPONDENCE TO:

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 SIGNATURE
Brian S. Myers
 NAME
46,947
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Filed Via Express Mail

Rec. No.: EL868036022US

On: December 14, 2001

By: 

Any fee due as a result of this paper, not covered by an enclosed check, may be charged on Deposit Acct. No. 50-1290.

Attorney Docket No.: HEIN 19.272

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor : **Heikki RÄISÄNEN**
 Serial No. : **Concurrently Herewith**
 Filed : **Concurrently Herewith**
 Title : **Method for the Manufacture of a Sensor Element,
 and a Sensor Element**

December 14, 2001

Assistant Commissioner for Patents
 Washington, D.C. 20231

PRELIMINARY AMENDMENT

S I R:

Prior to the issuance of an Office Action, please amend the application as follows:

In the Claims

Please amend claim 23 as follows:

23. (Amended) Sensor element as defined in claim 20, characterized in that it comprises insulators placed on both sides of the connection point to which the leads for connection to the sensor element are connected, said insulators being preferably watertight and designed to prevent water and moisture from getting into the connection.

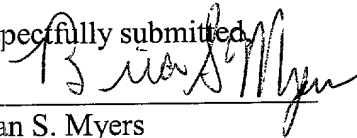
REMARKS

Claim 23 was amended to correct multiple dependency.

Attached hereto is a marked-up version of the changes made to the application by the current amendment. The attached page is captioned **"Version with markings to show changes made."**

Any fee due with this paper, not fully covered by an enclosed check, may be charged on Deposit Account 50-1290.

Respectfully submitted,



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VERSION WITH MARKINGS TO SHOW CHANGES MADE

In the Claims:

Claim 23 was amended as follows:

23. (Amended) Sensor element as defined in claim 20-~~or 22~~, characterized in that it comprises insulators placed on both sides of the connection point to which the leads for connection to the sensor element are connected, said insulators being preferably watertight and designed to prevent water and moisture from getting into the connection.

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JC13 Rec'd PCT/PTO 14 DEC 2001

METHOD FOR THE MANUFACTURE OF A SENSOR ELEMENT, AND A SENSOR ELEMENT

5 The present invention relates to a method for the manufacture of an electromechanical sensor element and to a sensor element.

10 Previously known is a so-called electret field, i.e. a permanent electric charge injected into a dielectric material by ionizing. A film applicable for use as a sensor film in the sensor element of the invention is presented in US patent specification 4,654,546, in which a dielectric plastic film, such as polypropylene, containing flat or torn gas bubbles is used to form a so-called electret bubble film. Both surfaces of the film are metal-coated. WO specification 96/06718 presents a method for swelling a foamed plastic film, whereby the amount of gas contained in the film can be more than doubled. Patent specification FI 913741 presents various electric structures for sensor elements. Previously known are also fibrous polarized electret films, as presented e.g. in US patent 4,874,659. Other known elements applicable in the sensor element of the invention are piezoelectric sensor films, such as PVDF.

20 Sensor elements and sensor bands as provided by the invention, which have a relatively large area or length, connected to a suitable signal processing apparatus or system, can be used for many different purposes. Possible applications are for example sensors installed in a road structure for determining the weight of a moving vehicle, registration and monitoring of a patient's vital functions (breathing, heartbeat and snoring) using a sensor placed in the bed under the mattress e.g. in conjunction with sleep research, monitoring of the vital functions of a drunken person by means of a sensor installed in the floor of a jail, sensors mounted under a carpet in an old-age home to monitor an old person's getting up from bed, sensors mounted under a floor coating in the vestibule of a bank or shopping center and connected to an alarm system. From a long sensor band installed on a fence around an industrial area, using suitable software, it is possible to obtain both contact data and position data when both ends of the sensor band are connected to a signal processing device. A sensor element may also be mounted inside a floor structure under a large machine, such as a paper machine, to monitor its operation. They can also be used in various safety applications, e.g. to make sure that a machine will not be started before its operator is in the proper place, and so on. In addition, this type of sensor elements can be used in sports e.g. to measure the force and duration of exer-

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tion. They can also be used as different kinds of switches, such as light switches, or in underwater ultrasound measurements. Moreover, a signal, e.g. an ultrasound signal can be fed into the sensor to make it vibrate. Sensors according to the invention can also be used in various keyboards, in cages for test
5 animals for the measurement of motional activity, monitoring of the vital functions of an animal recovering from a surgical operation, and so on. Typically, when such large sensor elements are applied, a plurality of sensors are used and the signals obtained from them can be compared and summed to eliminate unnecessary signals or to draw other conclusions, e.g. by installing several
10 sensors in the floor of the same space it is possible to eliminate e.g. signals produced by the vibration of an air conditioner or the building itself and pick out the breath and pulse of a person lying on the floor.

Traditionally, this type of large sensor elements or bands have been manufactured by cutting a sensor element of a size suited for the intended use e.g. from
15 sensor material coiled up on a roll and consisting of a metal film with sensor films, e.g. electrically charged electret bubble films, laminated on its both surfaces so that the positively charged sides lie against the metal film, with further metal films laminated against the negative side on the outer surfaces of the
20 laminate thus formed. When a force is applied to such an element, an electric charge is generated between the signal electrode in the core and the earth electrodes on the outer surfaces. A metal electrode may also be placed directly on the surface of the sensor film, e.g. by evaporating, as described e.g. in US patent specification 4,654,546. Another commonly used method is to print an
25 electrode pattern of silver pasta on the surface of a polyester film and laminate it together with a sensor film. With the first-mentioned methods, a problem in the manufacture of large sensor elements like this is that the sensors are sensitive to electromagnetic interference and discharge of static electricity. This is due to the fact that, as the sensor is cut from material in which the signal electrode
30 is of the same size with the sensor material, it extends to the very edges of the sensor element. Therefore, the edge areas of the elements need to be separately provided with metal films extending over the edges, these metal films being grounded. Another big problem is that when the material is being cut, the small metal particles released during cutting are apt to form a short circuit between
35 the signal electrode and the earth electrode. When the electrode surfaces are made from silk-screen printed silver pasta, the price becomes very high as silver pasta is very expensive. As compared with the manufacturing

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method of the invention, the price of an electrode surface printed with silver pasta is multiple times higher.

5 The object of the present invention is to eliminate the drawbacks of prior-art technology and to achieve a new manufacturing method that makes it possible to manufacture sensor material in an economic and environmentally friendly manner via mass production as continuous material from which it is possible to cut interference-free sensor elements that are suited for many uses and applications as desired. The invention also concerns a new technique for making
10 connections to sensors according to the invention.

In the method of the invention, both outer surfaces of a sensor film, such as a dielectric bubble film, in which a permanent electric charge has been injected by ionizing and which may also consist of a number of films glued together, are
15 provided with film-like metal electrodes, and the outer surface of at least one of the metal electrodes is provided with a film-like dielectric material, which may also consist of the same electromechanical sensor film. In the method, a sensor element is produced by cutting it from a larger amount of sensor element material in which at least the signal electrode has a patterned design.
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The features characteristic of the method and sensor element of the invention are presented in detail in the independent claims below.

25 The sensor element material according to a preferred embodiment of the invention can be cut at short distances into pieces of suitable size for each application, both crosswise and lengthways if necessary. Connections to the sensor material can also be easily made using advantageous tools as provided by the invention. A perforated sensor element according to an embodiment of the invention can also be reliably mounted on the surface of a finished concrete floor
30 or, during casting, inside the floor. The method of the invention is characterized by what is said in the claims below.

35 An embodiment of the invention is characterized in that repeated electrode patterns are formed at least in the signal electrode material, said patterns being connected to each other via one or more narrow connecting strips but otherwise disposed in separation from each other, and that the sensor element is formed from sensor element material by cutting the element into a desired length across the region of a connecting strip.

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An embodiment of the invention is characterized in that a connection to the zero, ground and signal electrodes of the sensor is made by cutting off pieces of the zero and ground electrodes from the outermost layers on opposite sides using a tool as provided by the invention. The tool makes a cut with a great accuracy, of the order of 5/100 mm, to a desired depth, allowing a connection to be made to the signal electrode in the core using a reliable crimp connector or rivet.

10 Another embodiment of the invention is characterized in that, in certain areas on the signal, ground and zero electrodes, a small spot on the aluminum electrode has been printed with silver pasta to ensure a connection as reliable as possible.

15 In a preferred embodiment of the invention, a typical feature is that its signal, ground and zero electrodes are manufactured by a silk-screen printing technique or by printing (e.g. ink jet printing), using e.g. a dielectric material dryable by UV light, an electrode pattern on the surface of the metal film placed on the dielectric film and etching off the portions outside the pattern. Both the printing, drying, etching and washing of the electrode pattern are performed in a roll-to-roll process. Likewise, the gluing together, i.e. lamination of the electrode material and the active electromechanical film is performed in a roll-to-roll process.

25 In an embodiment of the invention, in which the sensor element needs to be fastened as reliably as possible to the surface of a concrete floor, the element is provided with holes at regular distances, allowing the element to be fastened using a thin liquid cement-based putty for the leveling of concrete floors as it can stick directly to the floor surface via the holes. Such a sensor element can also be embedded inside a concrete casting at the casting stage and fastened to the reinforcements.

Another essential feature of a preferred embodiment of the invention is that the electret bubble film has been swelled before being charged, e.g. in a manner as described in WO publication 96/06718, thereby increasing the amount of gas
35 contained in it to a level exceeding 50%. When the film is then charged, its sensitivity after the swelling is increased to a value multiple times higher than for a film without swelling.

Further, when an electret bubble film is used, the invention is characterized in that the sensor element has been subjected to intensive aging by storing it for several days at a temperature slightly over the desired operating temperature, e.g. at 65°C when the desired maximum operating temperature is 60°C, the sensitivity of the sensor being thereby lowered as compared with the initial situation to a level of the order of 20 - 25% of the original sensitivity. This makes the sensor very stable for the desired maximum operating temperature. The storage temperature and period depend on the desired operating temperature. In normal conditions, a pre-aging treatment lowering the sensitivity by 50% as compared with the initial level is sufficient.

By the method of the invention, sensor element material can be manufactured fast and economically via mass production and coiled up in rolls, from which the material can be cut into pieces of desired length and width to form interference-free and reliable film-like sensor elements. In addition, the method of the invention, when aluminum electrodes are used, allowing the etching to be performed using iron chloride, is very economic and environmentally friendly.

In the following, the invention will be described in detail by the aid of an example with reference to the attached drawings, wherein

Fig. 1 presents a sensor element according to a preferred embodiment of the invention in lateral section,

Fig. 2a and 2b present the signal electrode of a sensor element according to the invention in top view,

Fig. 3A, 3B, 3C and 3D illustrate the production of signal electrode material,

Fig. 4 illustrates the patterning of the sensor band material, which allows the sensor to be cut at desired distances to make it shorter and/or narrower.

Fig. 5 presents tools for making connections to the sensor element,

Fig. 6 presents a sensor material with a serpentine signal electrode, and

Fig. 7 presents the signal electrode of a band-like sensor element that produces reliable position data.

A typical film-like sensor element according to the invention has a thin sensor film 1, e.g. an electret bubble film having a thickness of 0,07 mm, in the middle inside the element as shown in Fig. 1. Placed above and below the sensor film 1 are thin, e.g. 0.1 mm thick polyester films 2, 3 and 4. Films 2 and 3 are provided with thin aluminum films 5 and 6 of a thickness of e.g. 0.009 mm laminated on their sides facing the sensor film 1. The aluminum film 6 on the surface of film 3 facing film 1 is provided with patterns having the shape of pattern 41 presented in Fig. 2a. The aluminum film 5 on the surface of film 2 forms a continuous band-like pattern having a width of e.g. of the order of 50 cm, which preferably is wider than the pattern 41 on the surface of film 3. On the surface of film 4 there is likewise an aluminum film 7 identical to film 5, placed against film 3. Aluminum film 6 functions as the signal electrode of the sensor element. Aluminum film 5 functions as a zero electrode, i.e. reference electrode. Aluminum film 7 functions as a ground electrode, protecting the sensor against electromagnetic interference and static electricity discharges. Typically, aluminum films 5 and 7 are connected together, in which case they both also act as ground electrodes. The above description represents a preferred structure of the invention. It is also possible to use an arrangement in which the core of the sensor consists of a dielectric film with a pattern like pattern 41 provided on both of its outer surfaces, or even an arrangement in which the core merely consists of a thin metal film with patterns corresponding to pattern 41 made in it by etching. Laminated on either side of this core is a sensor film 1, and the outer surfaces of these two sensor films are provided with earth electrodes, which in this case are also zero electrodes. Another possible arrangement is one in which the aluminum film on the surface of film 2 has been patterned in a manner corresponding to pattern 41 and a film corresponding to film 4 with a ground electrode 7 on its surface has been laminated against film 2. In this case the result is a differential sensor. The aluminum electrodes against the sensor film function as signal electrodes, one positive and the other negative, while the outer aluminum films function as earth electrodes. Fig. 2b and 7 present an alternative, band-like signal electrode patterning. Sensor material like this can be cut lengthwise to make narrow sensors of a length of hundreds of meters if necessary.

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In the manufacture of sensor material (Fig. 3A), a dielectric/metal film 33 is used in which the supporting structure 34 is e.g. a polyester film, but which may also consist of polyethylene or polyimide or some other dielectric film suited for the

purpose. The sensor material is made by first laminating on the surface of film 33 a metal film 35, which preferably is of aluminum but which may also be a copper film, which may be later provided e.g. with tinning. However, it is more environmentally friendly to use aluminum film as it can be etched using iron chloride, the disposal of which produces less environmental stress than e.g. the substances used in the etching of copper. The dielectric/aluminum film 33 is unreeled from a roll 31 and it passes under a screen printing screen 37. By means of the screen, a desired pattern 39 is printed on the film from dielectric material 36 dryable e.g. by UV light. Each time a print has been made, the film is moved through a desired distance, yet a distance somewhat shorter than the pattern printed, successive prints thus partially overlapping. The pattern has been so designed that it allows repeated patterns to be printed. Instead of silk screen printing, it is also possible to use a device like an ink jet printer which prints the pattern on the film in tiny droplets. After the pattern has been printed, the film is moved forward through a desired distance, through an UV drying oven 38 and is further coiled up on a roll 32. In this manner, a repeated pattern can be printed. In a corresponding manner, an electrode can be printed with silver pasta on the surface of a clean dielectric film. However, this is considerably more expensive than the above-described method of etching the pattern from the aluminum film. After the desired pattern has been printed on the surface of the electrode film using a dielectric material that can withstand etching with iron chloride, the film roll 32 is transferred to an etching and washing line (Fig. 3B), where the metal in the metal surface 35 of the film 34 in the areas not covered by the dielectric film 36 is first etched away using iron chloride, leaving electrodes like e.g. those presented in Fig. 2A and 2B on the film. After this, the films are washed using e.g. a sodium hydroxide solution 38, which dissolves the printed dielectric material 36 away. The resulting film 33 is a finished film of electrode material. The zero and earth electrode film materials are manufactured in a corresponding manner. Further, the electrode material thus produced, in a manner corresponding to the printing of dielectric material, can be printed with silver pasta in the areas where connectors are to be connected to ensure a good electrical contact in a crimp connection. In this way, a very small amount of expensive silver is consumed as compared with printing the entire electrode surface with silver pasta.

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After this, all the films are laminated together using a roll-to-roll laminating apparatus (Fig. 3C). For example, referring to Fig. 1 at the same time, first the sensor film 1, which in a preferred embodiment of the invention is an electret bub-

ble film, and the dielectric/metal film 3, which has been manufactured by the method illustrated by Fig. 3A and 3B, are laminated together. The aluminum electrode side 6, which has been provided with a desired signal electrode pattern 39, and the sensor film 1 go against each other. In laminating the films together, glue 61 is applied e.g. to the sensor film 1 using a raster roller 62, after which the films are rolled together between rollers 63 and 64. The two films glued together are further rolled up on a roll 65. After this, still referring to Fig. 1, the film 2 with a zero or reference electrode pattern provided in the aluminum film 5 on one of its outer surfaces is laminated onto the laminate thus obtained. Further, to the laminate thus obtained, film 4, i.e. the earth electrode 7 is correspondingly added by laminating against film 3. As a final result, sensor film material as presented in Fig. 1 is obtained. From this material, sensor elements of a desired length are cut using a cutting device suited for the purpose, e.g. a knife. By the method of the invention, in which preferably a repeated pattern is used, it is thus possible to produce sensor elements of a very large length, even hundreds of meters, which consist of a plurality of sections connected together, yet with all their edges well protected against interference.

To a sensor according to the invention, connection leads can be reliably connected using crimp connectors to which the connection leads can be connected e.g. by soldering or crimping. For the crimp connectors, which are pressed through the whole sensor laminate and which thereby form an electric connection to the electrodes, the signal, earth and zero electrodes have been provided with areas to which the connectors can be pressed without creating a short circuit between the signal electrode and the earth/zero electrode. Typically, a sensor element according to the invention (Fig. 4) comprises a lug 44 extending laterally from the signal electrode and consisting of e.g. a wider continuous portion at the end of three leads having a width of the order of 1 mm, to which portion it is possible to connect several crimp connectors, manufactured e.g. by Nicomatic and Berg Electronics, to provide a reliable contact to the signal electrode. When a long sensor element is to be produced, the extra lugs 44 are cut off, thus avoiding interference through these. The earth and zero electrodes 5, 7 are so arranged that they extend in a lateral direction beyond the normal width of the signal electrode and further to the area of these three narrow leads. Thus, when the wide continuous portion is cut off, no extra interference will be produced because the total cross-sectional area of these three narrow leads in relation to the entire length of the side of the sensor is negligible. Further, as their cross-sectional area is so small, a tiny metal particle that may be released when

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the material is being cut will not cause a short circuit. The connections to the earth and zero electrodes are made using corresponding crimp connectors placed next to the lug 44. The leads are then connected to the crimp connectors e.g. by soldering.

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Using the technique of the invention, it is also possible to produce an element consisting of one or more sensor bands by arranging the signal electrode pattern so that, when the etching dielectric is being printed, a continuous band-like pattern 28 (Fig. 2B) is created. An alternative patterning of the narrow band-like sensor material is presented in Fig. 7, in which the connecting strips 49 are of a zigzag design. The width of the signal electrode band may be e.g. 10 mm and the spacing between them may be e.g. 20 mm. When a roll containing continuous sensor band patterns like this and also comprising earth and zero electrodes laminated to it is cut lengthways along the midlines between the signal electrode bands, sensor bands with a good protection against interference and, in the present case, having a width of 20 mm and a 10-mm active area are obtained. If desirable, when laminating the films together, it is possible to use glue that allows the end of the sensor band to be opened and the film layers to be detached from each other so that the electrode surfaces can be cleaned. Thus, the connection leads can be connected directly to different electrode layers.

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The connections to a sensor element (Fig. 2b, 4 and 7) according to a preferred embodiment of the invention with no separate lugs 44 specifically provided in it are made by cutting holes of a diameter of e.g. 15 mm in the outermost dielectric film layers 2 and 4, which have earth and zero electrodes 5 and 7 disposed on their inner surfaces, at any point where the innermost electrode is a signal electrode 44 or 28. The holes are cut using tools 71 and 72 according to the invention, manufactured for this purpose, as presented in Fig. 5A. Pieces of the earth and zero electrodes are cut off from opposite sides, whereupon it is possible to make connections to the signal electrode using crimp connectors or rivets. The tools 71 and 72 consist of two round pins having diameter of e.g. 20 mm. The pin 71 has an extension pin 73 of a diameter of e.g. 4 mm at the center of its end, and the other pin has a corresponding central hole 74, so one of the pins will go partially inside the other. Each pin has a circular cutting edge 75 of a diameter of 15 mm and a height of e.g. 0.1 mm when dielectric/metal films of a thickness of 0.085 mm are used. Now, after a hole 76 having, in the present case, a diameter of 4 mm has been first made in the sensor element using e.g. a suitable bayonet-type tool and the pins are inserted against each other

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- through the said hole and pressed against each other and rotated at the same time, the cutting edges will cut into the sensor to a depth such that the outermost films and the metal electrodes on them are incised and can be removed from the above-mentioned area 77 having a diameter of 15 mm while the signal electrode 41 at the core remains intact (Fig. 5B). Further, into this 4-mm hole is inserted a metallic tubular rivet 78, which, when pressed into place, will spread out to the very edges of the hole, thus making a contact 79 to the signal electrode. Under the rivet, a stiffening plastic washer 80 may be used on one side of the element while a toothed metallic washer 81 is placed on the other side to ensure a reliable contact. The rivet is provided with a lug 82 to which a lead can be connected by crimping or welding. In the edge area of the band, where there is no signal electrode at all, a hole is made in a corresponding manner and a rivet is pressed into it to make a connection to the earth and zero electrodes.
- The patterning of the element can be implemented as desired according to the intended use. In a manner corresponding to the patterns of the signal, earth and zero electrodes, it can also be provided with an antenna pattern if the sensor is used in a system involving the identification of an object producing an effect on the sensor or other type of identification using a so-called micro-tag, in which the antenna pattern picks out an individual signal of the micro-tag. Such an embodiment may be applicable e.g. in the measurement of sports performances, identification of a patient or identification of a vehicle passing over the sensor. The antenna pattern is preferably made on an extra dielectric/metal electrode film 33 laminated on the surface of the sensor element. The connection of a lead to the electrode can be implemented in a manner corresponding to the case described above. Instead of a tubular rivet, all the lead connections can also be made using crimp connectors having a plurality of small teeth that penetrate the material, as are manufactured e.g. by Nicomatic.
- Fig. 4 presents a part of the signal electrode of a preferred sensor element material according to the invention, which is applicable for many uses. Here, the signal electrode consists of checks 44 of a small size, e.g. 25 x 25 mm, with a relatively wide gap 47 between them. The checks are connected together by one or a few very narrow connector strips 46. The checks may naturally also comprise round shapes, e.g. their corners may be rounded, or they may also be completely circular. They may also be of a triangular shape or they may have more than four corners. From such a sensor element, it is easy to produce sensors of a desired shape, e.g. floor sensors by cutting the sensor element into

the desired shape using a corresponding grid or other alignment pattern arranged on the outer surface of the sensor element as an aid. Thus, it is possible to arrange for a connecting strip of a width of one check to run continuously from a sensor element mounted in the actual place of use to a wall and further up along the wall. This arrangement obviates the need to provide a connection lead under a carpet, where it would be readily visible and exposed to damage; instead, a completely unnoticeable floor sensor is achieved. A connection to such a sensor can be made in the manner described above. Further, a sensor element material with a signal electrode patterned in this manner can be provided with small holes 48, e.g. of a diameter of 10 mm, by punching by a roll-to-roll technique at regular distances in the areas 47 between the checks 44. Via such holes, the sensor element can be fastened to a concrete floor by means of surface leveling putty, which will fasten directly to the concrete in the area of the holes.

The cutting of the outermost layers without damaging the signal electrode can also be performed using a cutting device consisting of a pair of self-locking pliers with jaws, handles and a locking part for locking the jaws to a desired distance between them. The lower jaw is fitted with a horizontal metal plate and the upper jaw with a vertical cutter. Using such a cutting device, the earth and zero electrodes can be cut off from the sensor element by adjusting the cutter exactly to the correct depth, leaving the signal electrode layer intact.

After the leads have been connected to the crimp connectors and a metallic screen connected to the earth electrode has been arranged across the connection point if necessary, the connection point can be made watertight by pressing silicone pads of a sufficient size onto it using heat as an aid.

Fig. 6 further presents the cross-sectional structure of a sensor material according to the invention, which has a serpentine signal electrode 52 placed between two sensor films, such as e.g. elastic plastic films 51 of a bubble structure, while the outermost layers are film-like earth electrodes 53 made of a conductive material and having the same size as the plastic films 51. The sensors can be produced by cutting a sensor material manufactured by a roll-to-roll technique transversely between two adjacent, parallel electrodes. In this case, too, as the signal electrode is sufficiently narrow, its cross-sectional area in relation to that of the entire sensor element is very small, and therefore no disturbing interference will arise.

To the sensor element of the invention, it is possible to connect a transmitter-receiver apparatus for determining the intensity and point of application of a force or pressure applied to the sensor from the signals obtained from the sensor, comprising a transmitter unit working in the microwave range which sends
5 signals in the microwave range to the signal electrode of the sensor, and a receiver unit which receives the signals reflected back from the signal electrode.

To determine the intensity and point of application of a force or pressure applied
10 to the sensor from voltage signals obtained from the sensor, it is possible to make use of the connecting strips 49 of a signal electrode as presented in Fig. 7. Based on the delay introduced by the resistance of the connecting strips, it is possible to determine the point of application. By shaping the connecting strips in a zigzag fashion, thus increasing their length as much as possible, and using
15 a line width as small as possible, their resistance can be increased, thus facilitating the signal processing needed for the determination of position data.

It is obvious to the person skilled in the art that different embodiments of the invention are not restricted to the example described above, but that they can be
20 varied within the scope of the claims presented below.

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CLAIMS

1. Method for manufacturing an electromechanical sensor element, in which
5 method both surfaces of a sensor film (1) are provided with metallic electrodes
(5,6), said sensor element being produced by cutting it from a larger amount of
sensor element material, and in which method the electrodes in the manufac-
ture of sensor element material are produced in a continuous process from roll
to roll, and in which method the sensor element material is formed by laminating
10 in a continuous process from roll to roll, characterized in that at least the signal
electrode consists of a repeated electrode pattern (41), said patterns being at
least partially connected together via one or more narrow connecting strips (42),
and that the sensor element is formed from the sensor element material by cut-
ting it into a desired length and/or shape across the region of the connecting
15 strips.
2. Method as defined in claim 1, characterized in that the connecting strips pro-
vided in the sensor element material form a band-like electrode pattern, and
that a band-like sensor element is produced by cutting it from sensor element
20 material having one or more continuous connecting strips (28) of equal width
laid side by side.
3. Method as defined in claim 1, characterized in that at least some of the signal
electrode patterns are of a polygonal shape.
- 25 4. Method as defined in claim 1, characterized in that at least some of the signal
electrode patterns comprise round shapes.
5. Method as defined in claim 1, characterized in that the electrode material
30 mainly consists of aluminum.
6. Sensor element as defined in claim 1, characterized in that it is provided with
holes (47).
- 35 7. Sensor element as defined in claim 1, characterized in that the connecting
strips (49) have been laid in a zigzag pattern.

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8. Method for manufacturing an electromechanical sensor element, in which method both surfaces of a sensor film (1) are fitted with film-like metallic electrodes (5,6) and the outer surface of at least one of the metallic electrodes is fitted with a film-like dielectric material (2-4), said sensor element being produced by cutting it from a larger amount of sensor element material, characterized in that, in the manufacture of the sensor element material, the electrodes are created by printing a dielectric pattern corresponding to the electrode onto the surface of a metal film on the surface of the dielectric film (2-4) in a continuous processes from roll to roll (31,32) and removing the metallic matter from the areas outside the pattern by etching in a continuous process from roll to roll, and in which method the patterned film and the sensor film are laminated together in a continuous process from roll to roll, and in which at least the signal electrode material has been provided with repeated electrode patterning (41, 44).

9. Method as defined in claim 8, characterized in that the electrode patterns provided in the signal electrode material are at least partially interconnected via narrower connecting strips (42, 46).

10. Method as defined in claim 8, characterized in that at least some of the connecting strips (49) are laid in a zigzag pattern.

11. Method as defined in claim 8, characterized in that the signal electrodes (28) are of a band-like design and in which method a band-like sensor element is produced by cutting it from sensor element material comprising one or more continuous signal electrodes (28) of equal width placed side by side.

12. Method as defined in claim 8, characterized in that at least some of the signal electrode patterns are of a polygonal shape.

13. Method as defined in claim 8, characterized in that at least some of the signal electrode patterns comprise round shapes.

14. Method as defined in claim 8, characterized in that the electrode material is aluminum.

15. Method as defined in claim 8, characterized in that part of the surface of the aluminum electrode has been printed with silver pasta.

16. Electromechanical sensor element, in which both surfaces of a sensor film (1) have been fitted with film-like metallic electrodes (5,6) and the outer surface of at least one of said metallic electrodes has been fitted with a dielectric film (2,3), and in which sensor element at least one of the electrodes is provided with a patterning, characterized in that the sensor element has repeated electrode patterns (41,44), which electrode patterns have been formed from metal.
17. Sensor element as defined in claim 16, characterized in that at least some of the patterns provided in the sensor element are interconnected via narrow connecting strips (42, 46).
18. Sensor element as defined in claim 16, characterized in that at least some of the patterns are of a polygonal shape.
19. Sensor element as defined in claim 16, characterized in that at least some of the patterns comprise round shapes.
20. Sensor element as defined in claim 16, characterized in that it comprises connecting strips at the edge of the signal electrode pattern, said connecting strips consisting of thin strips and wider contact areas at the ends of these.
21. Sensor element as defined in claim 16, characterized in that the electrode material mainly consists of aluminum.
22. Sensor element as defined in claim 16, characterized in that an area has been cut off from at least one of the outer surfaces of the element in a manner such that the incision does not extend through the entire element, in which area a connector has been pressed to make a connection to the signal electrode.
23. Sensor element as defined in claim 20 or 22, characterized in that it comprises insulators placed on both sides of the connection point to which the leads for connection to the sensor element are connected, said insulators being preferably watertight and designed to prevent water and moisture from getting into the connection.
24. Sensor element as defined in claim 16, characterized in that the sensor element is provided with an antenna pattern.

25. Sensor element as defined in claim 16, characterized in that the connection to the signal electrode has been implemented by making a hole in the sensor element, into which hole a rivet has been pressed, which rivet has been compressed so that it has swollen in outside diameter so that the rivet has made an electric connection via its sides to the signal electrode.

26. Sensor element as defined in claim 16, characterized in that the sensor film consists of an electret bubble film which has first been expanded so that the amount of gas contained in it has been increased to a level exceeding 50%.

27. Sensor element as defined in claim 26, characterized in that the electromechanical sensor film consists of electret bubble film into which has been injected a permanent electric charge in an electric field so intensive that discharges have been produced inside the film.

28. Sensor element as defined in claim 27, which has been pre-aged so that its sensitivity after charging has been reduced by more than 50%.

29. Sensor element as defined in claim 16, which converts a mechanical force applied to the film-like sensor element into electric signals, which comprises film-like metallic electrodes fitted on both surfaces of an active electromechanical sensor film, said electrode patterns having been formed by etching from a metal film, characterized in that the surface material consists of a metal other than copper.

30. Sensor element as defined in claim 27, characterized in that it is connected to a transmitter/receiver unit working in the microwave range.

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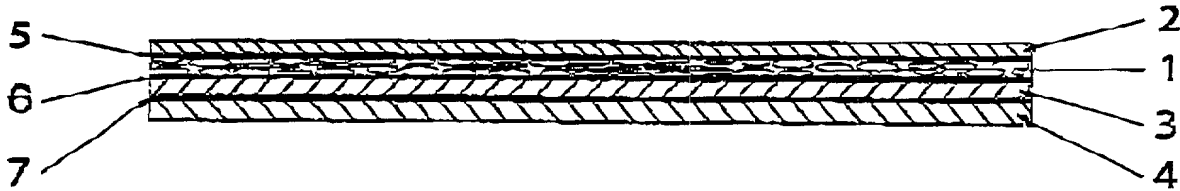


Fig. 1

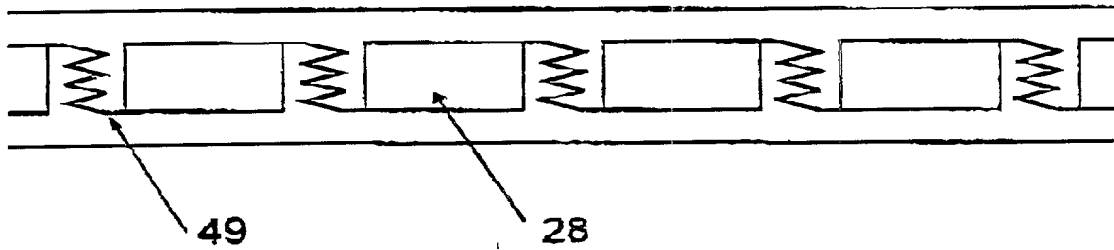


Fig. 7

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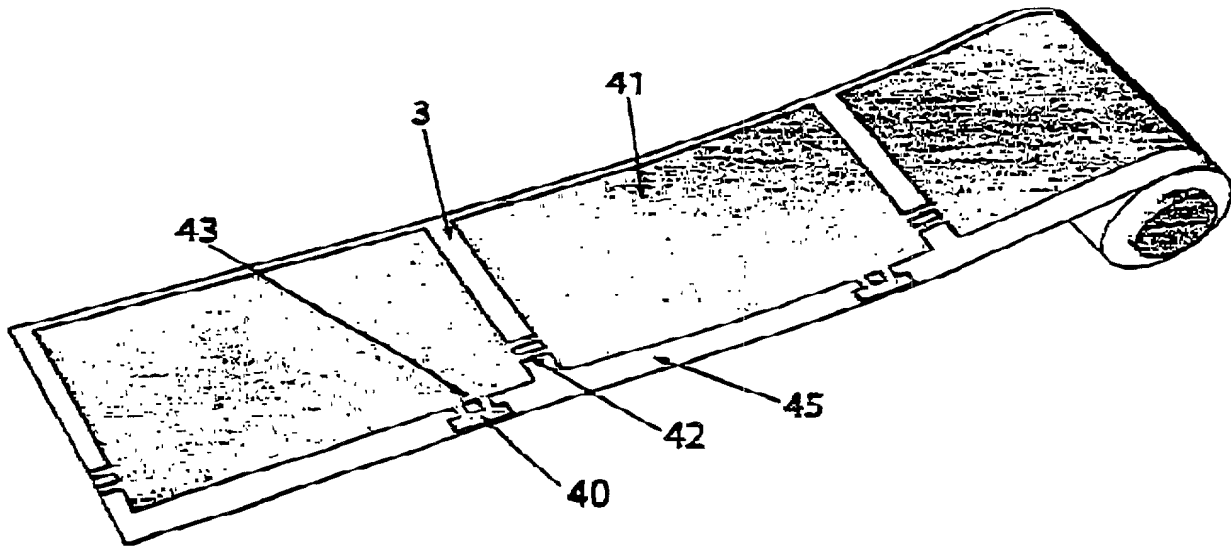


Fig. 2a

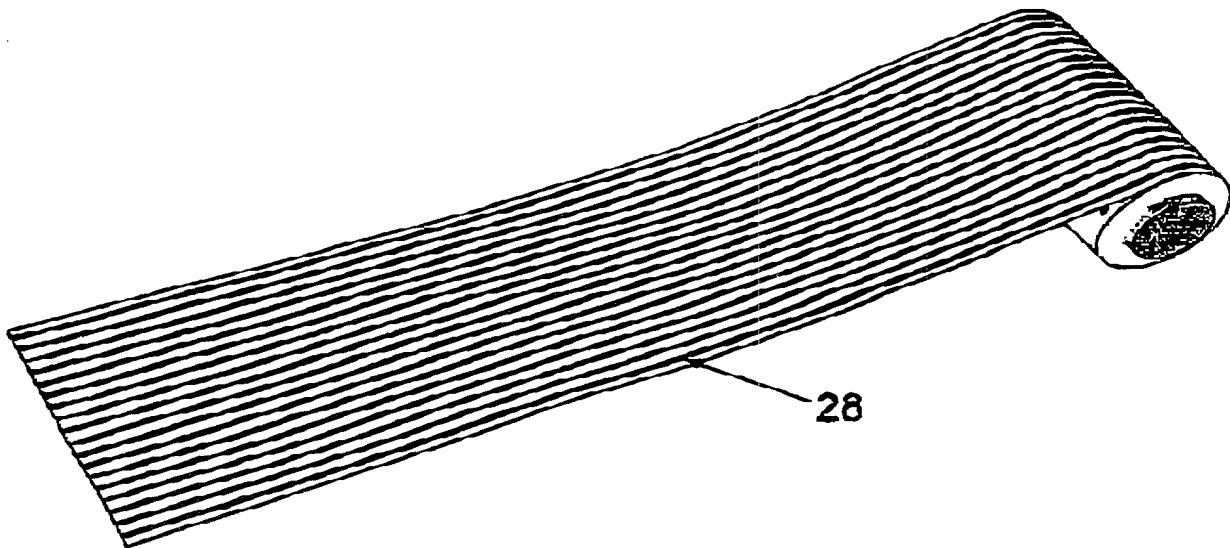


Fig. 2b

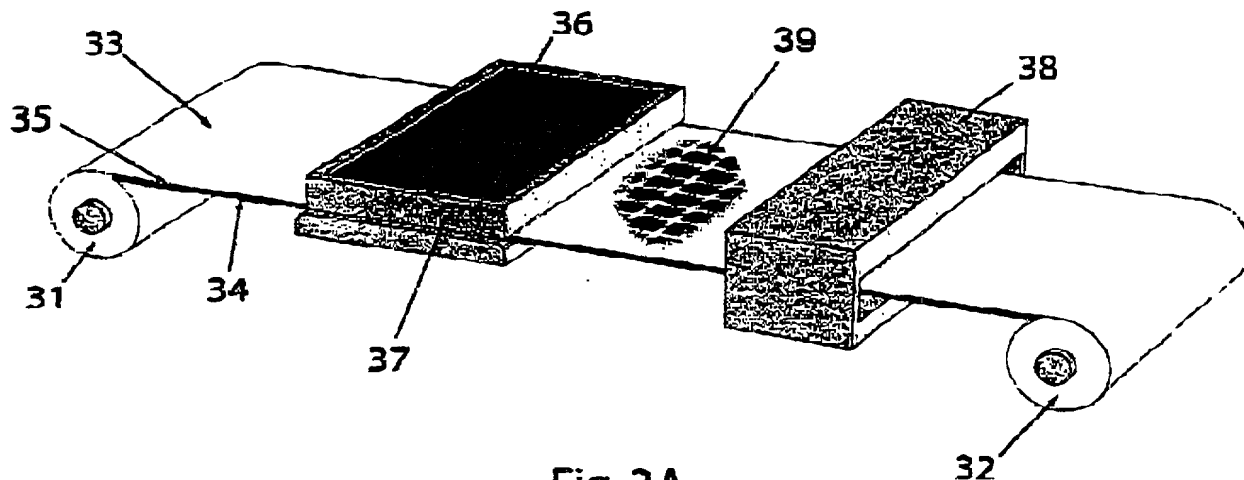


Fig. 3A

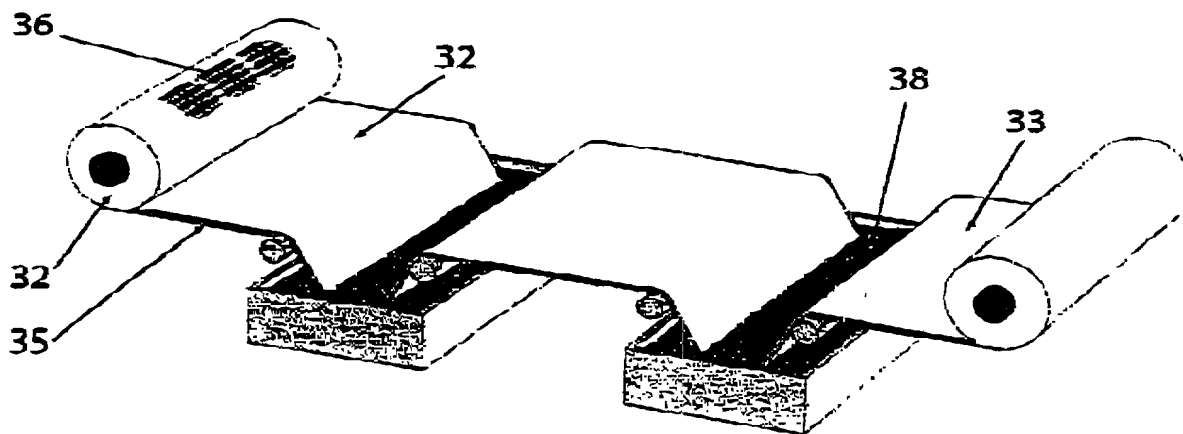


Fig. 3B

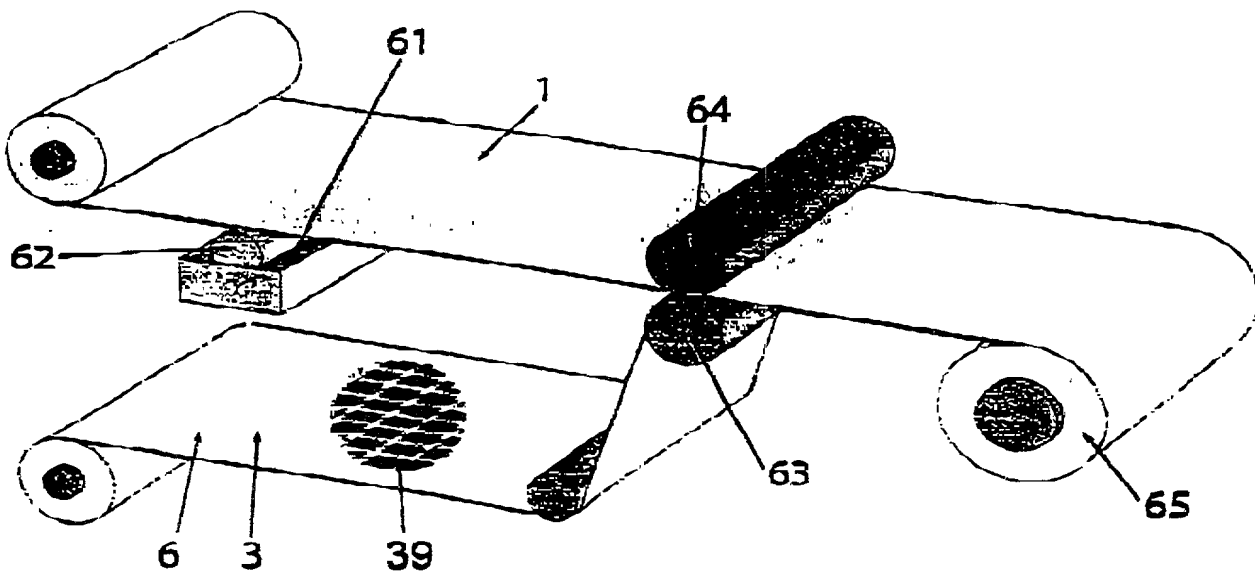


Fig. 3C

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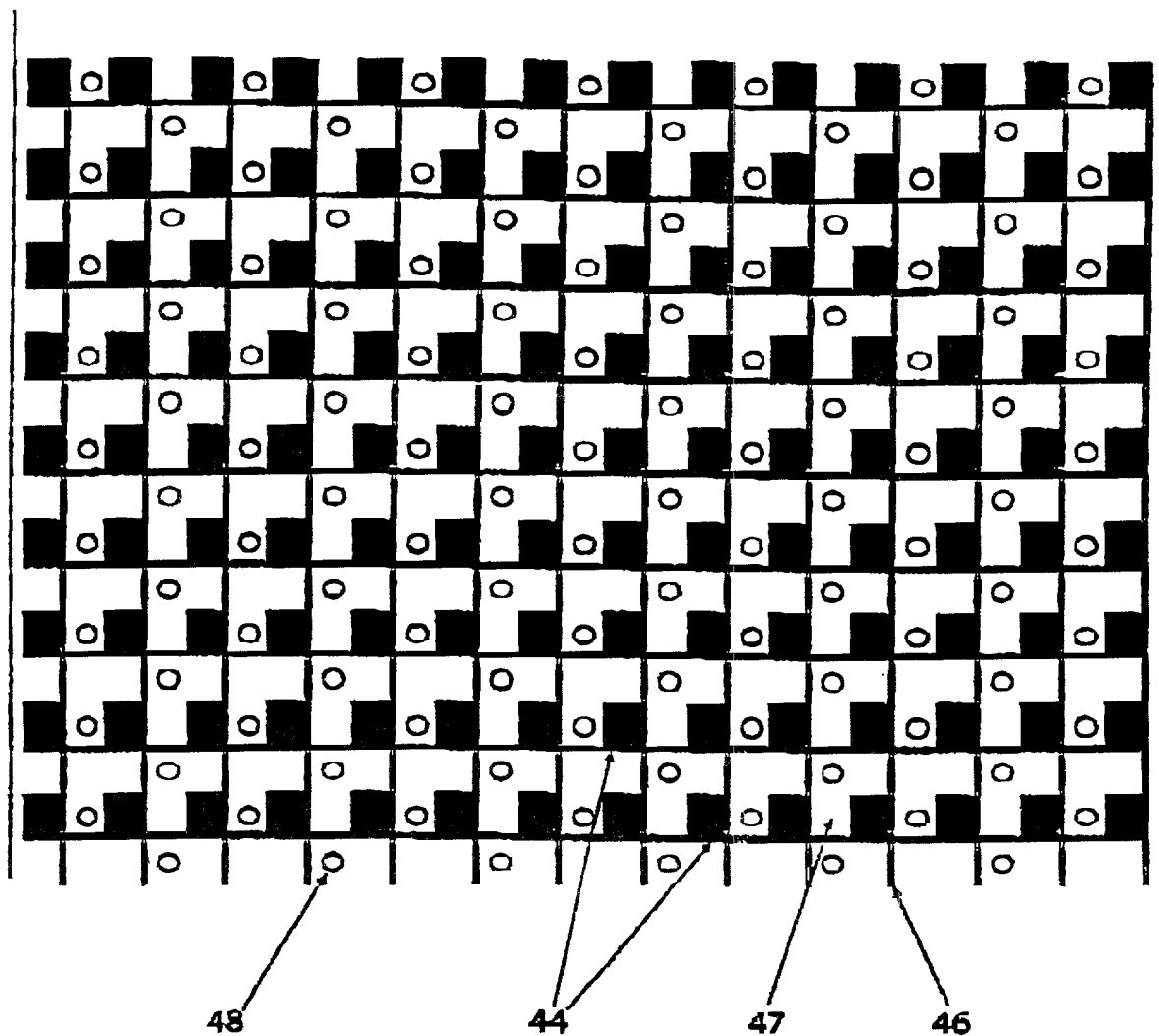
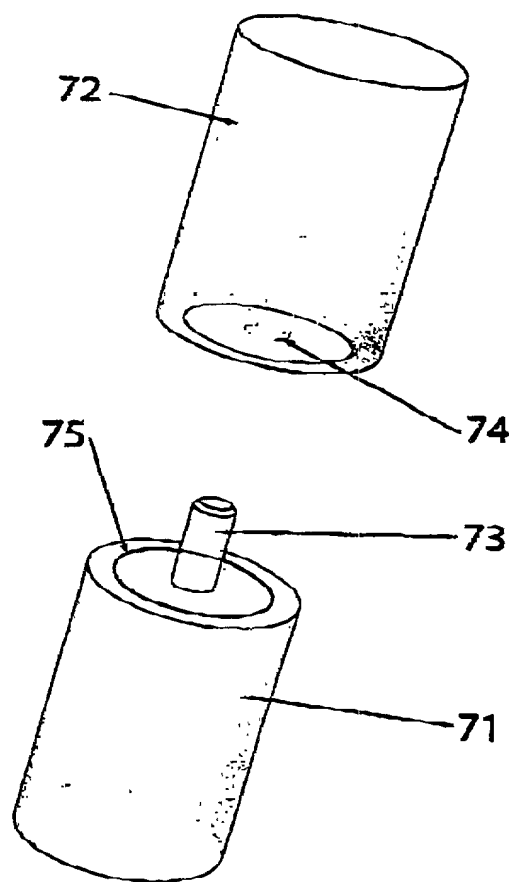


Fig. 4



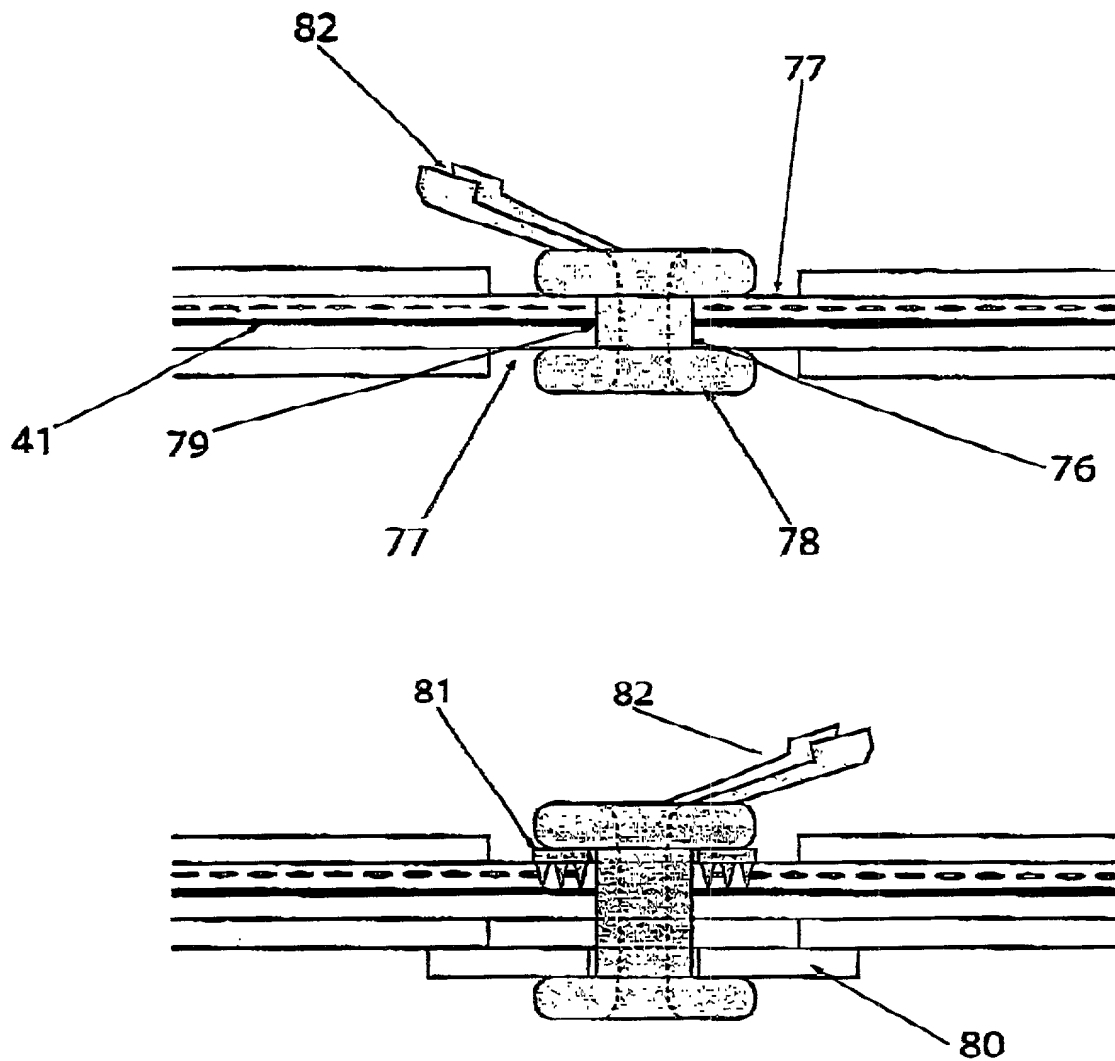


Fig. 5b

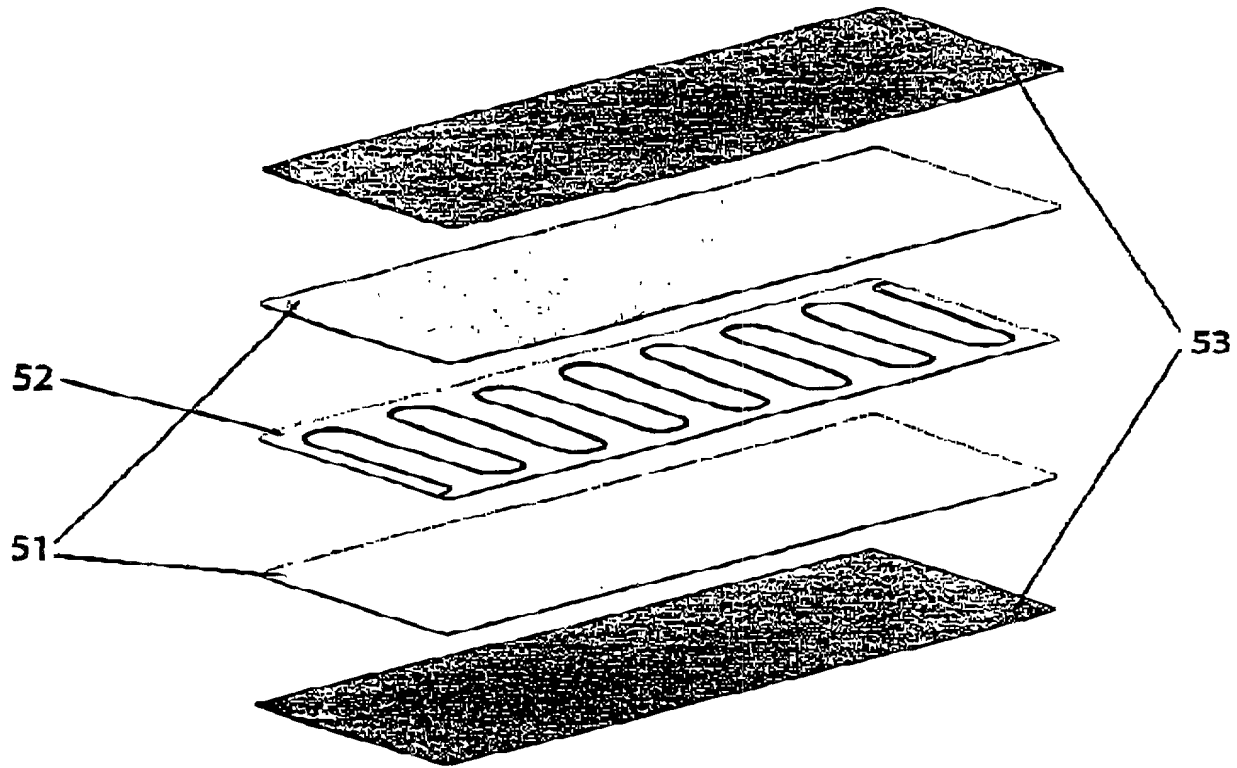



Fig. 6

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	First Named Inventor	Heikki RÄISÄNEN
	COMPLETE IF KNOWN	
	Application Number	10 / 018,413
	Filing Date	December 14, 2001
	Group Art Unit	
	Examiner Name	

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD FOR THE MANUFACTURE OF A SENSOR ELEMENT, AND A SENSOR ELEMENT

the specification of which (Title of the Invention)

☐ is attached hereto
OR
☒ was filed on (MM/DD/YYYY) **December 14, 2001** as United States Application Number or PCT International Application Number **10/018,413** and was amended on (MM/DD/YYYY) (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above

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991506	FI	July 1, 1999	<input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>	<input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>	<input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

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[Page 1 of 2]

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U.S. Parent Application or PCT Parent Number	Parent Filing Date (MM/DD/YYYY)	Parent Patent Number (if applicable)

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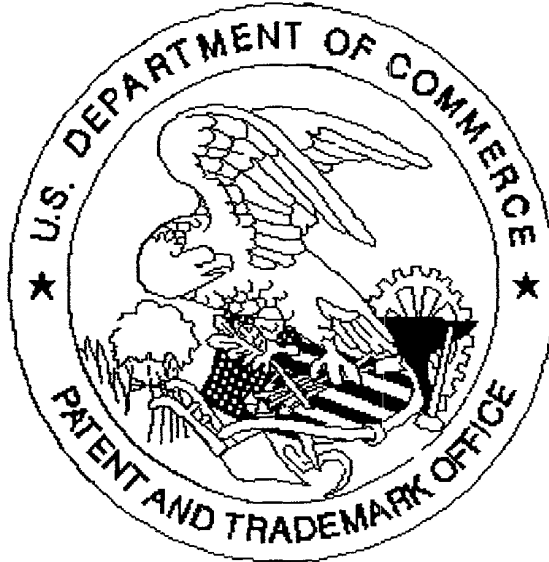
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